

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image





OMNIMATE[®] 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- · Optical and acoustic feedback indicates proper wiring

Create your own configuration

- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

Simply configuration of modular hybrid connectors















- Flexible combination options for power, signal and data transmission
- Future-proof Single-Pair Ethernet technology

General ordering data

Version	PCB plug-in connector, male header, THT/THR solder connection, Pitch in mm (P): 5.00 mm, Number of poles: 5, 270°, Tube
Order No.	8000072508
Туре	MHS 5/05 W T3 B T
GTIN (EAN)	4064675330882
Qty.	20 pc(s).
Product data	IEC: 400 V / 26.8 A UL: 300 V / 14 A
Packaging	Tube

Creation date October 11, 2022 8:18:22 PM CEST



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Technical data

Dimensions and weights

Depth	14 mm	Depth (inches)	0.551 inch
Height	14.1 mm	Height (inches)	0.555 inch
Height of lowest version	10.9 mm	Width	26.38 mm
Width (inches)	1.039 inch	Net weight	2.274 g

System specifications

T		Manustin name tha DCD	TUT /TUD Islam
Type of connection Board connection		Mounting onto the PCB	THT/THR solder connection
D: 1 : (D)			
Pitch in mm (P)	5 mm	Pitch in inches (P)	0.197 inch
Outgoing elbow	270°	Number of poles	5
Number of solder pins per pole	1	Solder pin length (I)	3.2 mm
Solder pin dimensions	1.0 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		Outside diameter of solder pad	2.3 mm
Template aperture diameter	2.1 mm	L1 in mm	20 mm
L1 in inches	0.787 inch	Number of rows	1
Pin series quantity		Touch-safe protection acc. to DIN VDE	Touch-safe above the
	1	57 106	printed circuit board
Touch-safe protection acc. to DIN VDE		Protection degree	
0470	IP 20		IP20
Volume resistance	≤5 mΩ	Plugging cycles	≥ 25
Plugging force/pole, max.	8.5 N	Pulling force/pole, max.	8.5 N

Material data

Colour	I.II.
· ·	black
O11 Insulating material group	p I
Moisture Level (MSL)	1
Contact base material	CuMg
Contact surface	tinned
Storage temperature, mi	in25 °C
Operating temperature,	min50 °C
,	
	O11 Insulating material grou Moisture Level (MSL) Contact base material Contact surface Storage temperature, m

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	26.8 A
Rated current, max. number of poles (Tu=20°C)	19.7 A	Rated current, min. number of poles (Tu=40°C)	23.1 A
Rated current, max. number of poles (Tu=40°C)	16.9 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Clearance, min.	4 mm
Creepage distance, min.	5.4 mm		

Rated data acc. to UL 1059

Rated voltage (Use group B / UL 1059) 300 V	Rated voltage (Use group D / UL 1059) 300 V
Rated current (Use group B / UL 1059) 14 A	Rated current (Use group D / UL 1059) 10 A



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Technical data

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01

al recognized lecorative properties n request.
components are to
•

Downloads

Engineering Data	CAD data – STEP	
Catalogues	Catalogues in PDF-format	

• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

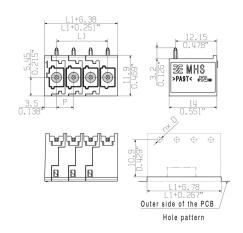
www.weidmueller.com

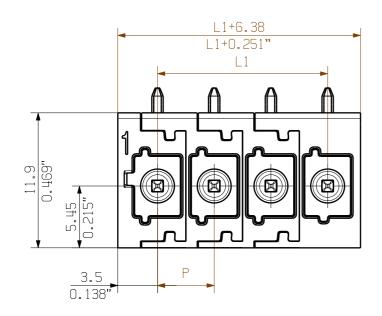
Drawings

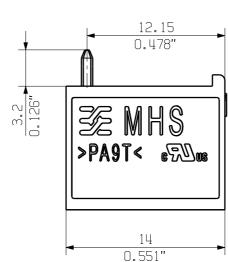
Product image

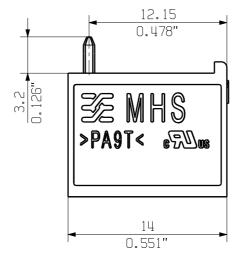


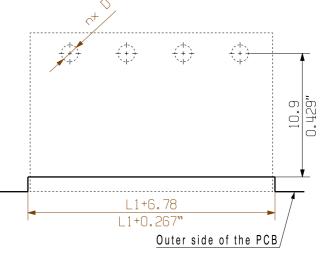
Dimensional drawing



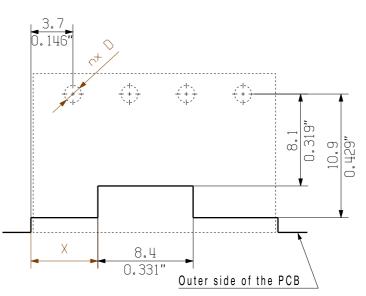








Hole pattern using MPS 5 without middle flange lever



Hole pattern using MPS 5 with middle flange lever

12		55.00	2.165	25.90	1.020
11		50.00	1.969	25.90	1.020
10		45.00	1.772	20.90	0.823
9		40.00	1.575	20.90	0.823
8		35.00	1.378	15.90	0.626
7		30.00	1.181	15.90	0.626
6		25.00	0.984	10.90	0.429
5		20.00	0.787	10.90	0.429
4		15.00	0.591	5.90	0.232
3		10.00	0.394	5.90	0.232
2		5.00	0.197	0.90	0.035
n		L1	L1	χ	Χ
Pol	es	[mm]	[inch]	[mm]	[inch]
Prim ERP Part No.: .					

Drawing no.

0

Issue no

Further Dim. & Info. See data sheet

DIN I

Scale: ./.

Drawings Assembly

General DIN ISO	tolerance: 2768-mK			M 1/1	
	B000400			Prim PLM	Part No.: .
ROHS	P038108 ·	Max. nos.		Weidmüller	
	First Issue Date				
	27.01.2021				
			Date	Name	
		Drawn	27.01.2021	Tauber-Reglin,	M

Stuckmann, Pet

Product file:

07.04.2021 | Sapina, Svetos

Responsible

Size: A3 Approved

MHS 5/... W T3 ...

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine. Weidmueller PCB components are tested according to the DIN EN 61984 or to the DIN EN 60947-7-4 standard,

and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



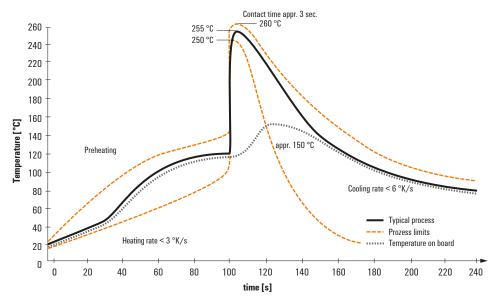
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

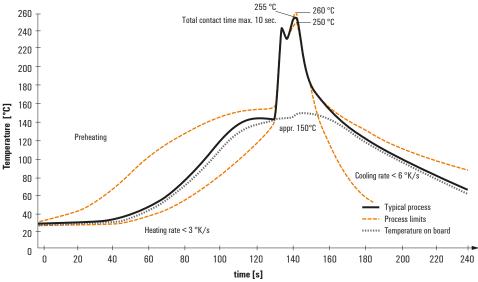
Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

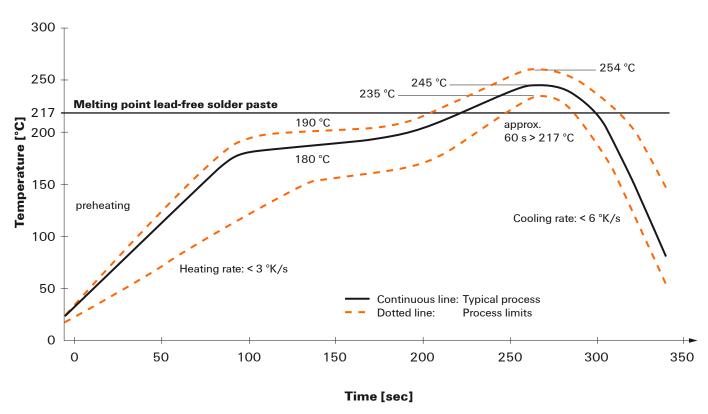


Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Pluggable Terminal Blocks category:

Click to view products by Weidmuller manufacturer:

Other Similar products are found below:

57.510.0053 MC 1.5/6-ST-3.5 GY AU ET02015000J0G 860505 860516 860810 GBPACX-12 93.731.4953.0 PV05-5,08-K PVP03-3,50 PVS02-5,00 1-1986160-3 1377680000 1531000000 1546228-5 ELFP03110 ELFP10210 ELFT07250 ELVD12100 ELVF09400 ELVP03100 ELXH071G0E 1700410 1746952 1760336 1809474 1855000000 19346 1946309 1950227 1973592 19892 25.320.4053.1 25.320.4553.9 25.320.4753.1 25.320.5453.1 25.340.0353.1 25.340.1053.1 25.345.3553.0M001 25.640.3553.1 SH02-5,08 SH06-3,81 SH08-5,08 SH08-5,08-K SH12-5,08 SHS04-5,00 30.303 30.305 30.306 1719561